

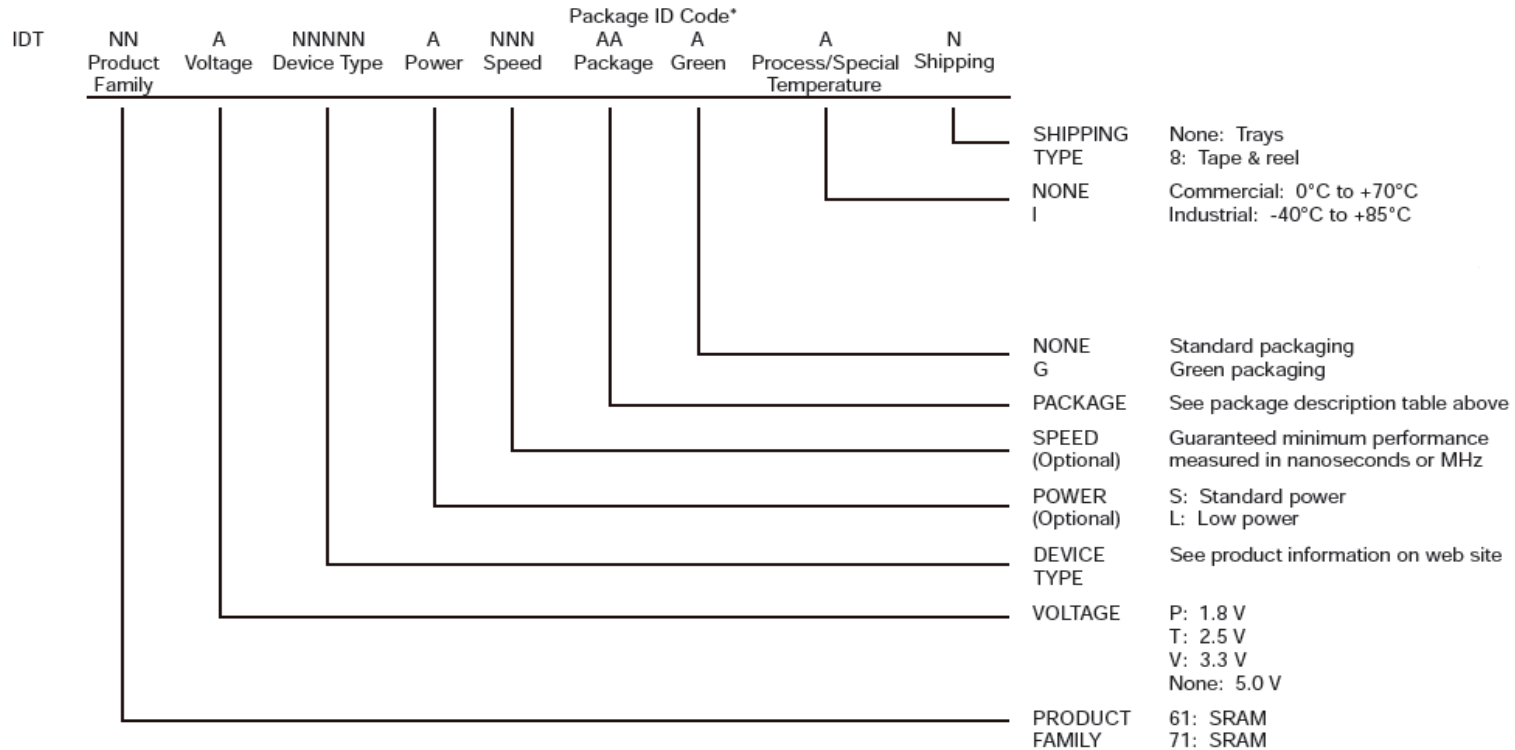
SRAM Products Ordering Information

Package Description Table

IDT ID	Abbr.	Description	IDT ID	Abbr.	Description
BE	CABGA	Chip Array Ball Grid Array	SO	SOIC	Small Outline Integrated Circuit
BF	CABGA	Chip Array Ball Grid Array	TY	SOJ	Small Outline J Form
BQ	CABGA	Chip Array Ball Grid Array	Y	SOJ	Small Outline J Form
D	CDIP	Ceramic Dual In-line Package	Y	SOJ	Small Outline J Form (300 mil)
TD	CDIP	Ceramic Dual In-line Package	Y	SOJ	Small Outline J Form (400 mil)
L	LCC	Leadless Chip Carrier	PF	TQFP	Thin Quad Flat Package
BG	PBGA	Plastic Ball Grid Array	PH	TSOP	Thin Small Outline Package (Type II)
TP	PDIP	Plastic Dual In-line Package	PZ	TSOP	Thin Small Outline Package

Part Number Description

A = Alpha Character N = Numeric Character



* Please see "Packaging Overview" section for IDT package ID codes.